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SCAS860B - OCTOBER 2008 - REVISED MARCH 2012

RAD-TOLERANT CLASS V, HEX SCHMITT-TRIGGER INVERTER

Check for Samples: SN54AC14-SP

FEATURES

•	2-V to 6-V V _{CC} Operation	J OR W PACKAGE (TOP VIEW)		
•	Inputs Accept Voltages to 6 V	, L		, –
•	Max tpd of 9.5 ns at 5 V	1A [1 1	4 V _{CC}
•	Rad-Tolerant: 50 kRad(Si) TID (1)	1Y []	2 1	3 🛛 6A
	 TID Dose Rate < 2mRad/sec 	2A []	3 1	2 6 Y
_		2Y []	4 1	1 5 A
•	QML-V Quaimed, SMD 5962-87624	ЗА [5 1	0 5Y
(1)	Radiation tolerance is a typical value based upon initial device	3Y [6	9 🛛 4A
(-)	qualification. Radiation Lot Acceptance Testing is available - contact factory for details.		7	8 4 Y

DESCRIPTION/ORDERING INFORMATION

These Schmitt-trigger devices contain six independent inverters. They perform the Boolean function $Y = \overline{A}$. Because of the Schmitt action, they have different input threshold levels for positive-going (V_{T+}) and for negative-going (V_{T-}) signals.

These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean, jitter-free output signals. They also have a greater noise margin than conventional inverters.

ORDERING INFORMATION⁽¹⁾

T _A PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
EE%C to 125%C	CDIP – J	Tube	5962-8762402VCA	5962-8762402VCA
-55°C 10 125°C	CFP – W	Tube	5962-8762402VDA	5962-8762402VDA

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

FUNCTION TABLE (EACH INVERTER)						
INPUT A	OUTPUT Y					
Н	L					
L	Н					

LOGIC DIAGRAM, EACH INVERTER (POSITIVE LOGIC)





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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	7	V
VI	Input voltage range ⁽²⁾		-0.5	V _{CC} + 0.5	V
Vo	Output voltage range ⁽²⁾		-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	$V_{I} < 0 \text{ or } V_{I} > V_{CC}$		±20	mA
I _{OK}	Output clamp current	V ₀ < 0		±20	mA
I _O	Continuous output current	$V_{O} = 0$ to V_{CC}		±50	mA
	Continuous current through V_{CC} or GND			±200	mA
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded provided the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2	6	V
VI	Input voltage		0	V_{CC}	V
Vo	Output voltage		0	V_{CC}	V
		$V_{CC} = 3 V$		-12	
I _{OH}	High-level output current	$V_{CC} = 4.5 V$		-24	mA
OH		$V_{CC} = 5.5 V$		-24	
		$V_{CC} = 3 V$		12	
I _{OL}	Low-level output current	$V_{CC} = 4.5 V$		24	mA
		$V_{CC} = 5.5 V$		24	
T _A	Operating free-air temperature		-55	125	°C

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	V	T _A = 25°C		T _A = –55°C TO 125°C		
PARAMETER	TEST CONDITIONS	Vcc	MIN	MAX	MIN	MAX	UNIT
V _T .		3 V		2.3		2.3	
Positive-going		4.5 V		3.2		3.2	V
threshold		5.5 V		3.9		3.9	
VT		3 V	0.5		0.5		
Negative-going		4.5 V	0.9		0.9		V
threshold		5.5 V	1.1		1.1		
		3 V	0.3	1.3	0.3	1.3	
Hysteresis	is	4.5 V	0.4	1.4	0.4	1.4	V
$(V_{T+} - V_{T-})$		5.5 V	0.5	1.6	0.5	1.6	
		3 V	2.9		2.9		
	I _{OH} = -50 μA	4.5 V	4.4		4.4		
		5.5 V	5.4		5.4		
V _{OH}	I _{OH} = -12 mA	3 V	2.56		2.4		V
	I _{OH} = -24 mA	4.5 V	3.86		3.7		
		5.5 V	4.86		4.7		
	$I_{OH} = -50 \text{ mA}^{(1)}$	5.5 V			3.85		
		3 V		0.1		0.1	
	I _{OL} = 50 μA	4.5 V		0.1		0.1	
		5.5 V		0.1		0.1	
V _{OL}	I _{OL} = 12 mA	3 V		0.5		0.5	V
	1 24 - 24	4.5 V		0.5		0.5	
	$I_{OL} = 24 \text{ IIIA}$	5.5 V		0.5		0.5	
	$I_{OL} = 50 \text{ mA}^{(1)}$	5.5 V				1.65	
I _I	$V_{I} = V_{CC}$ or GND	5.5 V		±0.1		±1	μA
I _{CC}	$V_{I} = V_{CC}$ or GND, $I_{O} = 0$	5.5 V		4		80	μA
I _{CCt}	$V_{I} = V_{CC}/2 V$ One input at V _I , other input at V _{CC} or GND ⁽²⁾	5.5 V		7.5		7.5	mA
Ci	$V_I = V_{CC}$ or GND	5 V		8		8	pF

(1) Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

(2) V_{I} is incremented in 0.1-V steps to 3.7 V.

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SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V, C_L = 50 pF (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	Τμ	₄ = 25°C		T _A = –55°C T	O 125°C		
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	UNIT	
t _{PLH}	A	V	1.5	6	13.5	1	16	2	
t _{PHL}		ř	1.5	6	11.5	1	14	ns	

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V, C_L = 50 pF (unless otherwise noted) (see Figure 1)

	FROM	то	Т	$T_{\rm A} = 25^{\circ}{\rm C}$ $T_{\rm A} = -55^{\circ}{\rm C}$		T _A = -55°C	TO 125°C	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	UNIT
t _{PLH}	A		1.5	5	10	1.5	12	20
t _{PHL}		ř	1.5	5	8.5	1.5	10	ns

OPERATING CHARACTERISTICS

 $V_{CC} = 5 \text{ V}, \text{ } \text{T}_{\text{A}} = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	$C_{L} = 50 \text{ pF}, \text{ f} = 1 \text{ MHz}$	25	рF



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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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REVISION HISTORY

Changes from Revision A (March, 2010) to Revision B Page • Added I_{CCt} parameter to Electrical Characteristics 3

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W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



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EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





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